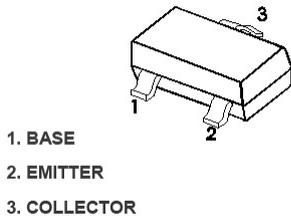


**SOT-23**

**SOT-23 贴片塑封三极管**  
**SOT-23 Plastic-Encapsulate Transistors**



**Marking: BA**

**特征 Features**

- 与 C1815 配对; Complementary to C1815
- 最大功率耗散 200mW; Power Dissipation of 200mW
- 高稳定性和可靠性。High Stability and High Reliability

**机械数据 Mechanical Data**

- 封装: SOT-23 封装 SOT-23 Small Outline Plastic Package
- 环氧树脂 UL 易燃等级 Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any

极限值和温度特性(TA = 25°C 除非另有规定)

**Maximum Ratings & Thermal Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
Collector-Base Voltage	V <sub>CBO</sub>	-50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-50	V
Emitter -Base Voltage	V <sub>EBO</sub>	-5	V
Collector Current-Continuous	I <sub>C</sub>	-150	mA
Collector Power Dissipation	P <sub>C</sub>	200	mW
Junction Temperature	T <sub>j</sub>	150	°C
Storage Temperature	T <sub>stg</sub>	-55-+150	°C
Thermal resistance From junction to ambient	R <sub>θJA</sub>	625	°C/W

电特性 (TA = 25°C 除非另有规定)

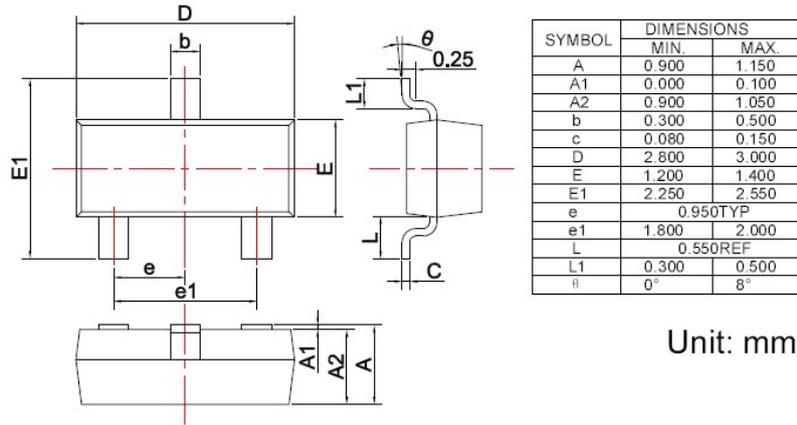
**Electrical Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameter	符号 Symbols	测试条件 Test Condition	界限 Limits		单位 Unit
			Min	Max	
Collector-base breakdown voltage	V(BR)CBO	IC=-10uA, IE=0	-50		V
Collector-emitter breakdown voltage	V(BR)CEO	IC=-1mA, IB=0	-50		V
Emitter-base breakdown voltage	V(BR)EBO	IE=-10uA, IC=0	-5		V
Collector cut-off current	ICEO	VCE=-50V, IE=0		-100	nA
Collector cut-off current	ICBO	VCB=-50V, IE=0		-100	nA
Emitter cut-off current	IEBO	VEB=-5V, IC=0		-100	nA
DC current gain	hFE	VCE=-6V, IC=-2mA	130	400	
Collector-emitter saturation voltage	VCE(sat)	IC=-100mA, IB=-10mA		-0.30	V
Base -emitter saturation voltage	VBE(sat)	IC=-100mA, IB=-10mA		-1.10	V
Transition frequency	ft	VCE=-10V, IC=-1mA, f=30MHz	80		MHz

**CLASSIFICATION OF hFE**

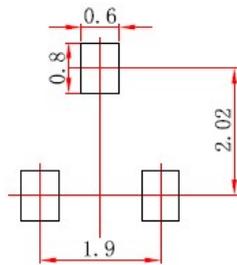
HFE	130-400	
RANK	L	H
RANGE	130-200	200-400

SOT-23 PACKAGE OUTLINE Plastic surface mounted package



焊盘设计参考 Precautions: PCB Design

Recommended land dimensions for SOT-23 diode. Electrode patterns for PCBs



- Note:
1. Controlling dimension: In millimeters.
  2. General tolerance: ± 0.05mm.
  3. The pad layout is for reference purposes only.